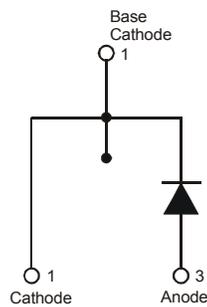


## Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**

## Mechanical Data

- Case: TO220AC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish – Tin. Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Marking: Type Number
- Weight: 2.24 grams (approximate)



Package Pin Out Configuration

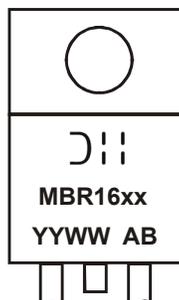
## Ordering Information (Note 3)

Part Number	Case	Packaging
MBR16xx*	TO220AC	50/Tube

\* xx = Device type, e.g. MBR1640

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



MBR16xx = Product Type Marking Code  
 AB = Foundry and Assembly Code  
 YYWW = Date Code Marking  
 YY = Last two digits of year (ex: 10 = 2010)  
 WW = Week (01 - 53)

### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60 Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	MBR 1635	MBR 1640	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35	40	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	24.5	28	V
Average Rectified Output Current (Note 4) @ T <sub>C</sub> = +125°C	I <sub>O</sub>	16		A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	150		A

### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 4)	R <sub>θJC</sub>	1.5	°C/W
Voltage Rate of Change (Rated V <sub>R</sub> )	dV/dt	1000	V/μs
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Forward Voltage Drop @ I <sub>F</sub> = 16A, T <sub>C</sub> = +25°C @ I <sub>F</sub> = 16A, T <sub>C</sub> = +125°C	V <sub>FM</sub>	0.63 0.57	V
Peak Reverse Current @ T <sub>C</sub> = +25°C at Rated DC Blocking Voltage @ T <sub>C</sub> = +125°C	I <sub>RM</sub>	0.2 40	mA
Typical Total Capacitance (Note 5)	C <sub>T</sub>	450	pF

Notes: 4. Thermal resistance junction to case mounted on heatsink.  
5. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

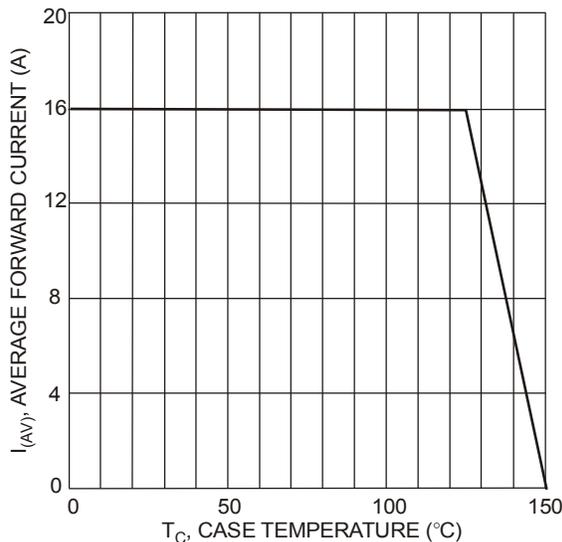


Fig. 1 Forward Current Derating Curve

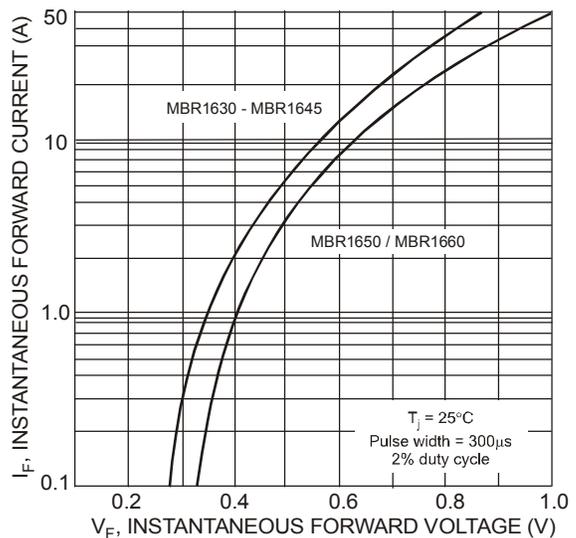


Fig. 2 Typical Forward Voltage Characteristics

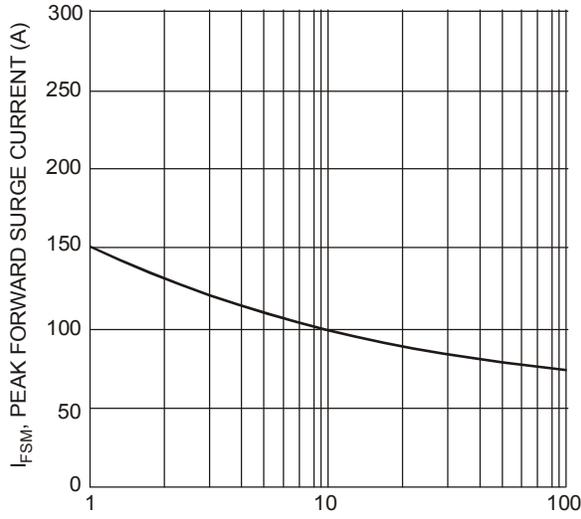


Fig. 3 Max Non-Repetitive Surge Current

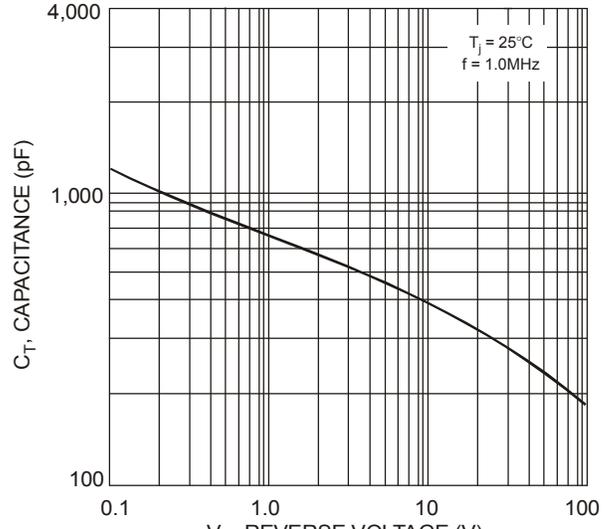


Fig. 4 Typical Total Capacitance

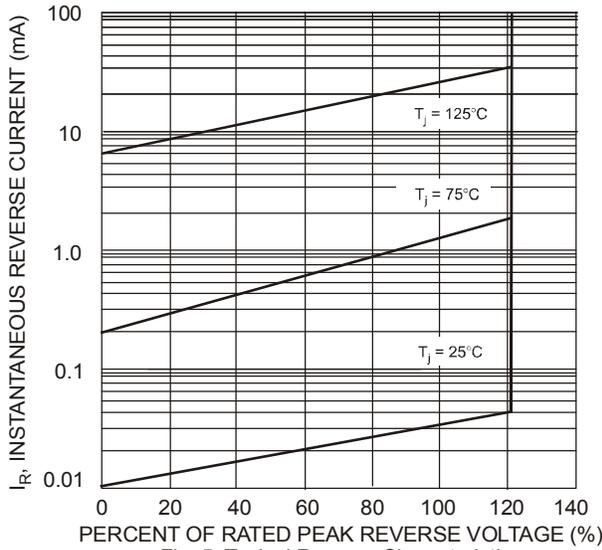
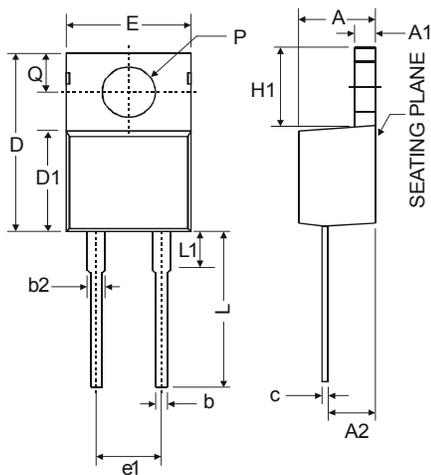


Fig. 5 Typical Reverse Characteristics

**Package Outline Dimensions**

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



TO220AC			
Dim	Min	Typ	Max
A	3.56	-	4.82
A1	0.51	-	1.39
A2	2.04	-	2.92
b	0.39	0.81	1.01
b2	1.15	1.24	1.77
c	0.356	-	0.61
D	14.22	-	16.51
D1	8.39	-	9.01
e1	5.08		
E	9.66	-	10.66
H1	5.85	-	6.85
L	12.70	-	14.73
L1	-	-	6.35
P	3.54	-	4.08
Q	2.54	-	3.42
<b>All Dimensions in mm</b>			

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